

17128  
650.00698  
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Reissue Application of: ) THERMOPLASTIC ELASTOMER  
HIROHIDE ENAMI et al ) COMPOSITION FOR POWDER  
Reissue U.S. Patent No. 5,948,850 ) SLUSH MOLDING AND PROCESS  
Serial No. 09/815,414 ) FOR PREPARATION OF  
Filed March 22, 2001 ) SAID COMPOSITION  
)  
) Group Art Unit 1712  
)  
) Examiner David E. Aylward

#8  
2/3/03  
11c

PETITION UNDER 37 CFR 1.136

RECEIVED

JAN 30 2003

TC 1700

Box REISSUE  
Commissioner for Patents  
Washington, D.C. 20231

Sir:

A retroactive two-month extension of time is requested, extending the time for filing a response to the Office Action until January 21, 2003. A check in the amount of \$410.00 is enclosed to cover the fee.

37 CFR 1.8  
CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Box Reissue, Commissioner for Patents, Washington, D.C. 20231, on January 21, 2003.

Signature: Karen Sanderson

Name: Karen Sanderson

01/28/2003 CCHAU1 00000102 09815414

01 FC:1252

410.00 OP

650.00698  
PATENT

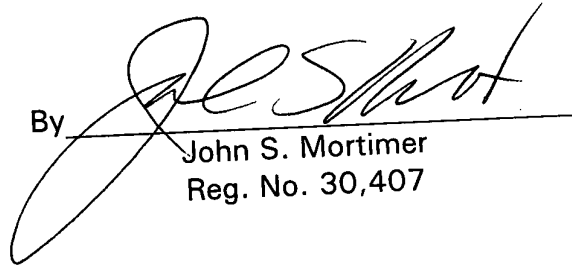
Please charge any overpayment or underpayment to our Deposit

Account No. 23-0785.

Respectfully submitted,

WOOD, PHILLIPS, KATZ,  
CLARK & MORTIMER

By

A handwritten signature in black ink, appearing to read "JSM", is written over a horizontal line.

John S. Mortimer  
Reg. No. 30,407

January 21, 2003

500 West Madison Street  
Suite 3800  
Chicago, IL 60661-2511  
(312) 876-1800